

National Centre for Flexible Electronics



Call for Expression of Interest

Flexible and stretchable multi-layer PCBs

Background

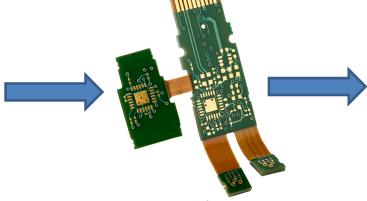
Rigid

Rigid-Flex

Flexible



www.rpcelectronics.com



www.spectracad.com



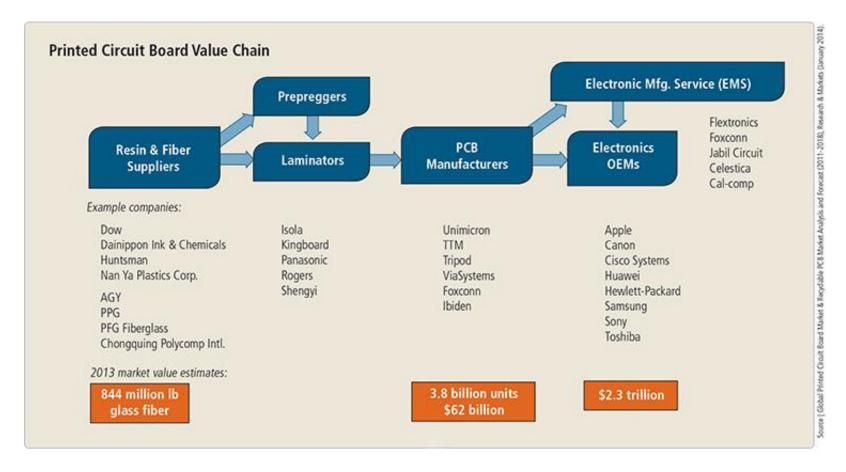
www.multi-circuit-boards.eu

 TVs, Laptops, tablets, mobile phone and other conventional electronics gadgets - Night vision goggles, hearing aids, wearable devices and other applications requiring bending operations. Needed for applications requiring various form factors and extreme bendability

- Flexible PCB technology needs to precede flexible electronics product



PCB Ecosystem

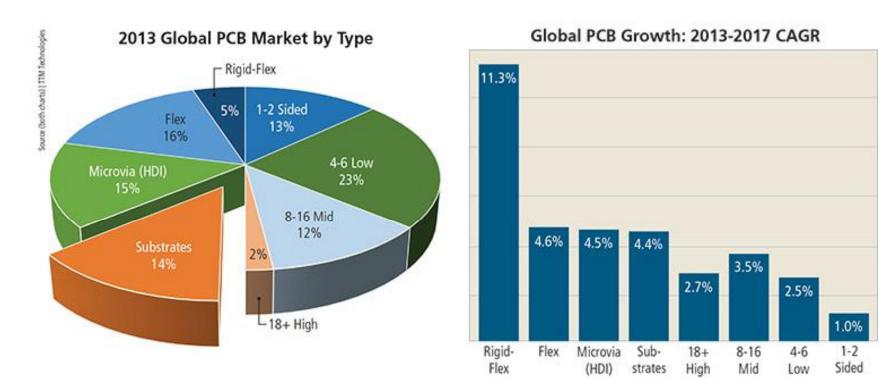


www.conpositesworld.com, TTM Technologies

PCB applications are spread across the broad value chain



Market Size and Potential



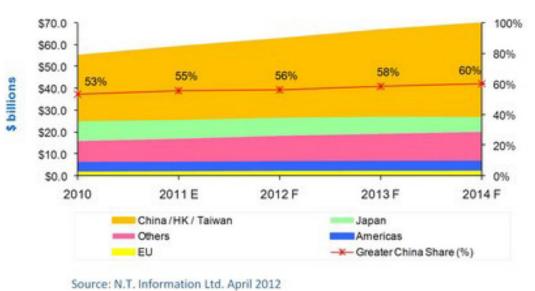
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Flexible and Rigid-Flex PCB market is showing higher growth rate compared to rigid only

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Challenges – India Specific





Region	2010 \$B	2014 \$B	10 /14 CAGR
China / HK / Taiwan	\$29.3	\$42.2	8.8%
Japan	\$9.9	\$7.6	-7.0%
SE Asia, Korea, Others	\$9.7	\$13.3	7.9%
Americas	\$3.4	\$3.7	2.6%
EU	\$2.8	\$3.2	2.5%
World	\$55.1	\$70.0	5.8%

- Indian Flexible PCB industry has negligible global presence
- Also, Indian flexible PCB industry is not yet ready for flexible electronics market
- ⇒ Need for an R&D push for flexible (and stretchable) PCB industry



Proposed Solution

 FlexE Centre is developing a <u>roll-to-roll</u> compatible additive multi-layer flexible and stretchable PCB manufacturing technology

Printing Infrastructure
- Sheet-to-sheet
- Roll-to-roll
Laser machining
infrastructure
Conductive inks
- Cu, Ag, Au

Development of S-2-S multilayer PCB (Coated PI and Cu ink)

Technology transfer to Roll-to-Roll Electrical and mechanical characterization

Integration on flexible and wearable electronic devices (e.g. smart bandage)



Advantages of proposed solution

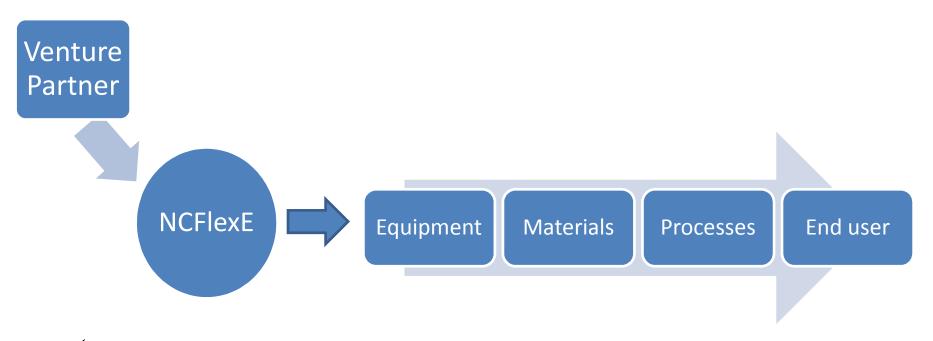
- Additive technology
 - Less material consumption
 - Non-vacuum processes
 - ⇒ Cheaper and greener

Roll-to-roll process ⇒ high through-put

 Validation of the flexible PCB technology on electronic devices developed by FlexE Centre



Call for Partners



- ✓ We are seeking partners across the value chain shown above
- ✓ We are looking for partners to enable the scaling and manufacturability of the developed processes
- ✓ Preferential terms for early partners



Contact Information

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Also visit our webpage for more details on partnership models and other technology domains: www.ncflexe.in

